

5V 2A 1.3MHz Synchronous Buck Converter

1.Description

The FDK0520 is a high-efficiency, DC-to-DC step-down switching regulators, capable of delivering up to 2A of output current.

The device operates from an input voltage range of 2.5V to 5.5V and provides an output voltage from 0.6V to VIN, making the FDK0520 ideal for low voltage power conversions. Running at a fixed frequency of 1.3MHz allows the use of small external components, such as ceramic input and output caps, as well as small inductors, while still providing low output ripples.

This low noise output along with its excellent efficiency achieved by the internal synchronous rectifier, making FDK0520 an ideal green replacement for large power consuming linear regulators. Internal soft-start control circuitry reduces inrush current. Short-circuit and thermal-overload protection improves design reliability. The FDK0520 is available in a SOT23-5 Package.

2.Features

- 2.5V to 5.5V Input Voltage Range
- Capable of Delivering 2A
- 1.3MHz Switching Frequency
- No External Schottky Diode Needed
- Light-load Mode
- Internal Compensation and Soft-Start
- Current Mode control
- 0.6V Reference for Low Output voltages
- Logic Control Shutdown (IQ<1uA)
- Thermal shutdown and UVLO
- Available in SOT23-5

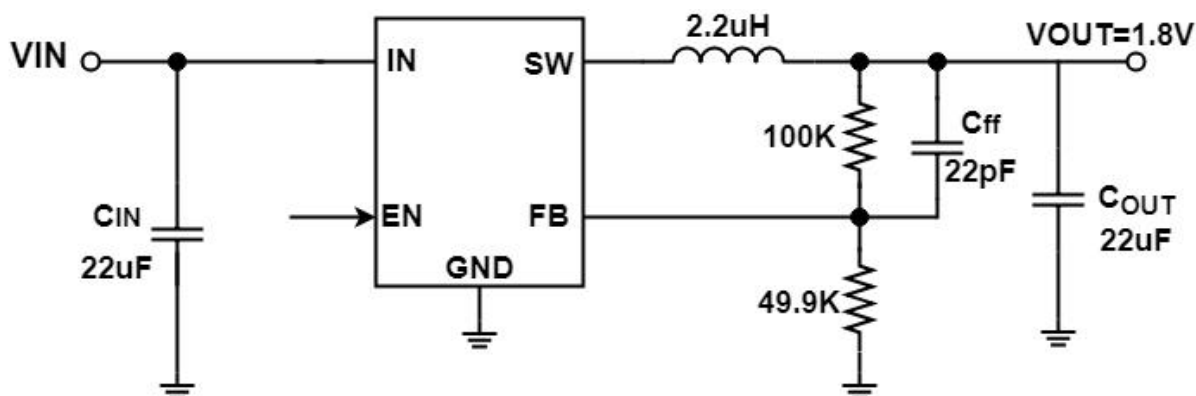
3.Applications

- Digital Cameras
- MP3 and MP4 players
- Set top boxes
- Wireless and DSL Modems
- USB supplied Devices in Notebooks
- Portable Devices

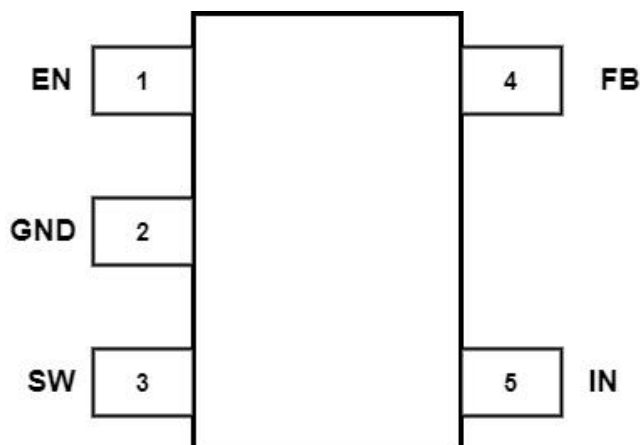
4.Order information

Mode	Package	Specified Temperature range	Ordering Number	Packing Option
FDK0520	SOT23-5	-40℃ to +85℃	FDK0520YSOT235G/TR	Tape and Reel,3000

5.Typical Application



6.Pin Configuration



7.Pin Description

Pin Name	Pin No.	Pin Function
EN	1	Enable pin
GND	2	Ground
SW	3	Power Switch Output
IN	4	Power Supply Input
FB	5	Feedback input pin

8.Absolute Maximum Ratings

- Max Input Voltage-----5.6V
- Max Operating Junction Temperature(T_j)-----125°C
- Ambient Temperature(T_a)----- -40°C~+85°C
- Maximum Power Dissipation -----400mW
- Lead Temperature (Soldering, 10 sec.) -----260°C
- Storage Temperature ----- -40°C to 150°C

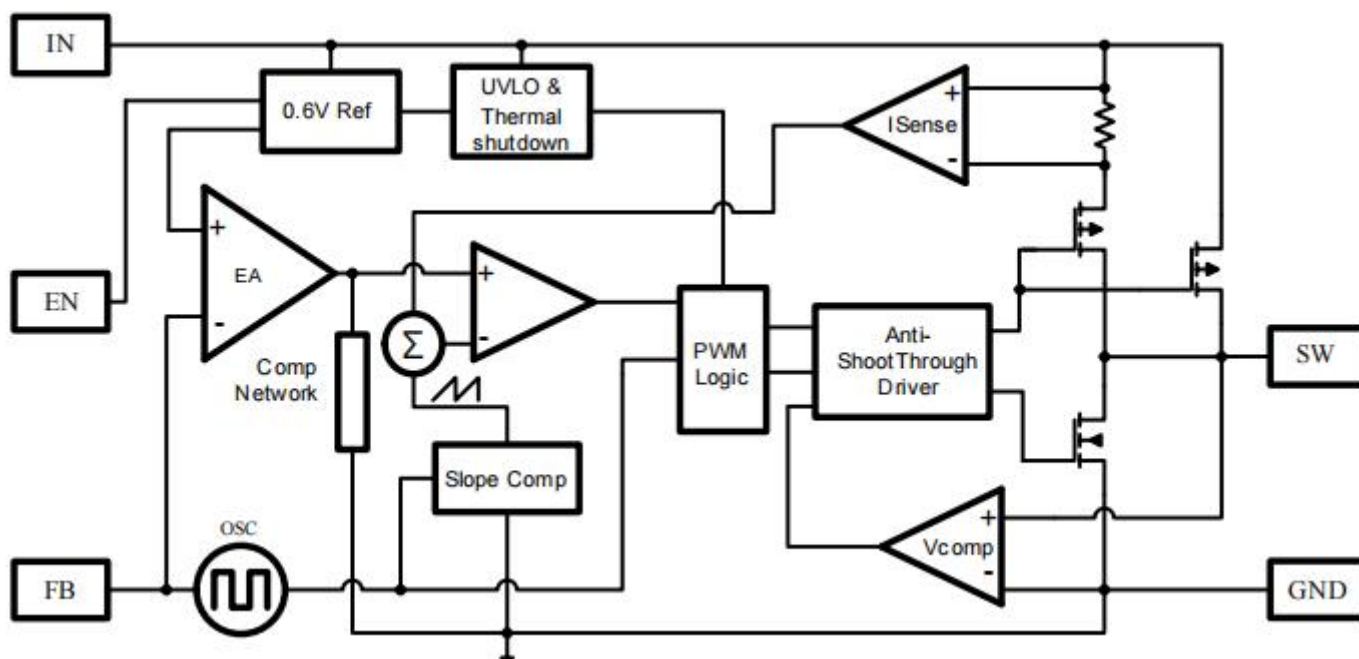
Note:

Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Recommended Operating Range indicates conditions for which the device is functional, but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Range. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

9.Recommanded Operating Range

- VIN Supply Voltage----- 2.5V to 5.5V
- Operating Temperature ----- -40°C to +85°C

10.Functional Block Diagram



11. Electrical Characteristics

$V_{IN}=5V, T_A=25^{\circ}C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IN}	Input Voltage Range		2.5		5.5	V
V_{UVLO}	Input UVLO Threshold			2.3	2.5	V
V_{HYS}	Input UVLO Hysteresis			0.3		V
V_{FB}	Feedback Voltage		0.585	0.6	0.615	V
I_Q	Quiescent Current			90		μA
I_{SD}	Shutdown Current	$V_{EN}=0$		0.2	1	μA
F_{SW}	Switching Frequency	$I_{OUT}=2A$		1.3		MHz
R_{ONP}	PMOSFET $R_{DS(ON)}$			120		m Ω
R_{ONN}	NMOSFET $R_{DS(ON)}$			80		m Ω
I_{LIMIT}	Peak Current Limit		2.5			A
V_{ENH}	EN Input High Voltage		1			V
V_{ENL}	EN Input Low Voltage				0.8	V
T_{SD}	Thermal Shutdown			155		$^{\circ}C$
T_{HYSTSD}	Thermal Shutdown Hysteresis			20		$^{\circ}C$

12. Typical Performance Characteristics

Tested under $T_A=25^{\circ}\text{C}$, $V_{in}=5\text{V}$, $V_{out}=1.8\text{V}$, unless otherwise specified.

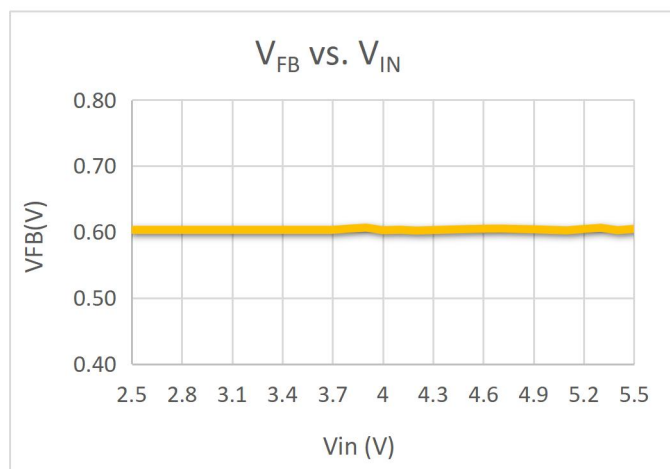


Fig 1. V_{FB} vs V_{IN}

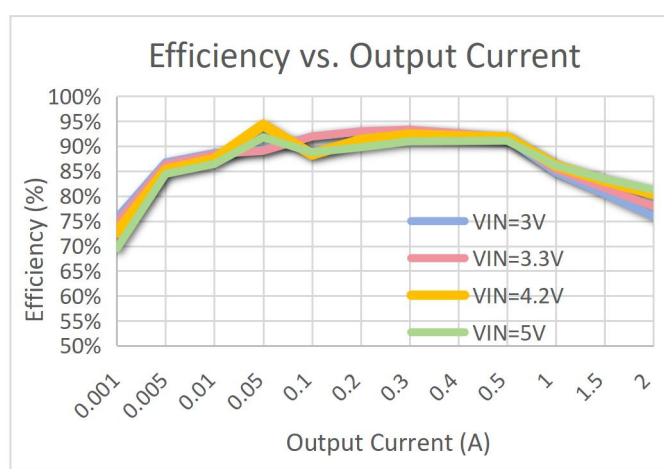


Fig 2. Efficiency vs Output Current

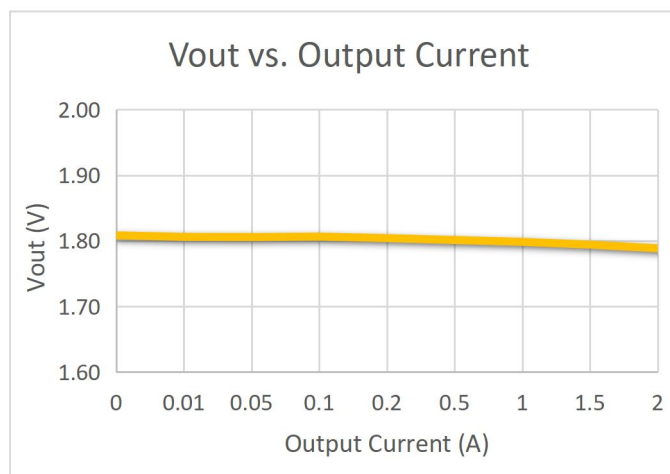


Fig 3. V_{out} vs. Output Current

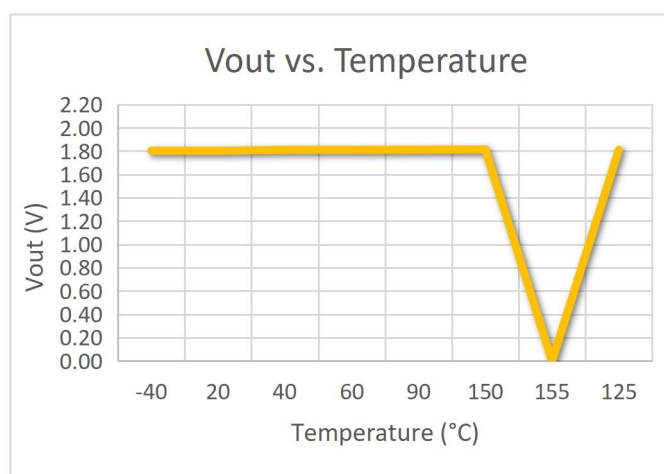


Fig 4. V_{out} vs. Temperature

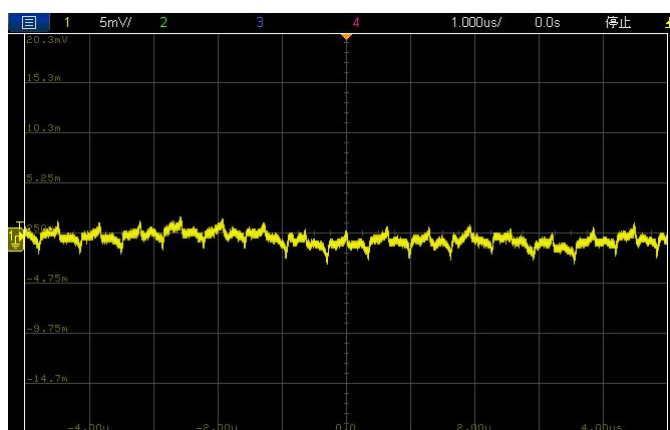


Fig 5. Output Ripple (Load=2A)
(V_{out} : 5mV/div; Time: 100us/div)

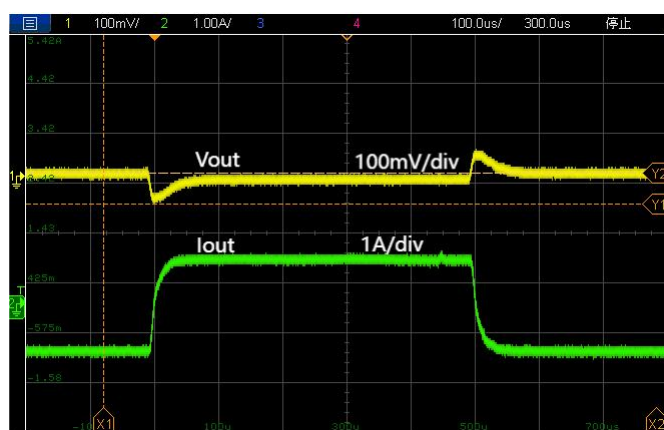


Fig 6. Load Transient ($I_{OUT}=0.2\sim 2.0\text{A}$)
(Time: 100us/div)

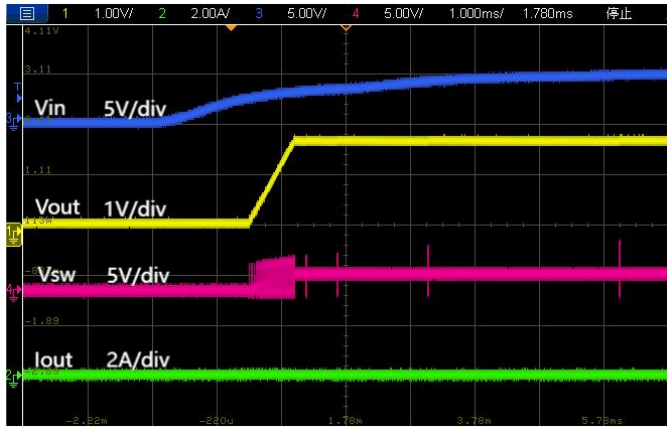


Fig 7. V_{IN} Power ON($I_{OUT}=0A$)
(Time:1ms/div)

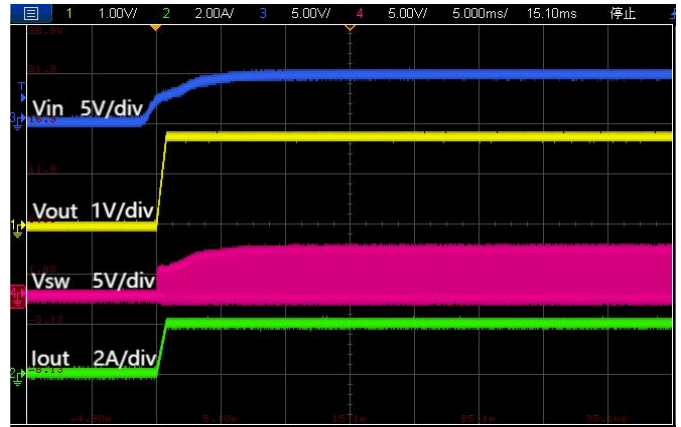


Fig 8. V_{IN} Power ON($I_{OUT}=2A$)
(Time:5ms/div)

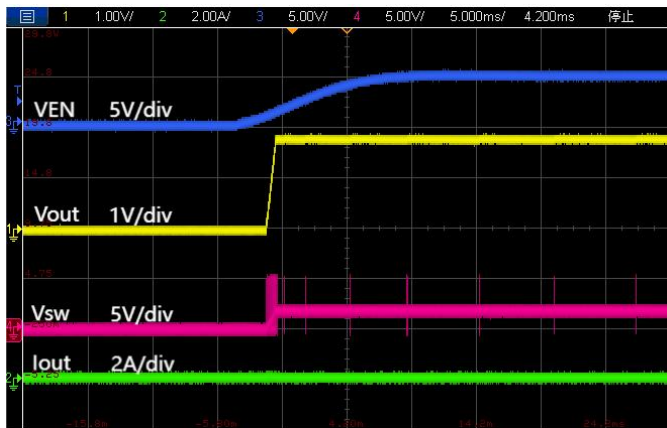


Fig 9. EN Power ON($I_{OUT}=0mA$)
(Time:5ms/div)



Fig 10. EN Power ON($I_{OUT}=2A$)
(Time:2ms/div)

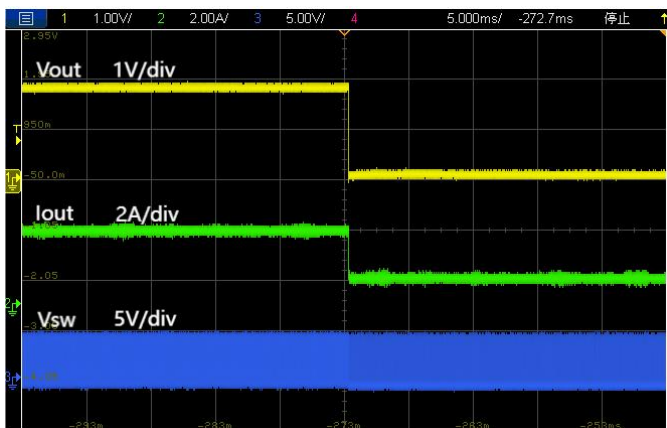


Fig 9. Short-Circuit Response($I_{OUT}=2.0A \sim \text{Short}$)
(Time:5ms/div)

13.Operation Description

The FDK0520 high-efficiency switching regulator is a small, simple, DC-to-DC step-down converter capable of delivering up to 2A of output current. The device operates in pulse-width modulation (PWM) at 1.3MHz from a 2.5V to 5.5V input voltage and provides an output voltage from 0.6V on, making the FDK0520 ideal for on-board post-regulation applications. An internal synchronous rectifier improves efficiency and eliminates the typical Schottky free-wheeling diode. Using the on resistance of the internal high-side MOSFET to sense switching currents eliminates current-sense resistors, further improving efficiency and cost.

● Loop Operation

The FDK0520 uses a PWM current-mode control scheme. An open-loop comparator compares the integrated voltage-feedback signal against the sum of the amplified current-sense signal and the slope compensation ramp. At each rising edge of the internal clock, the internal high-side MOSFET turns on until the PWM comparator terminates the on cycle. During this on-time, current ramps up through the inductor, sourcing current to the output and storing energy in the inductor. The current mode feedback system regulates the peak inductor current as a function of the output voltage error signal. During the off cycle, the internal high-side P-channel MOSFET turns off, and the internal low-side N-channel MOSFET turns on. The inductor releases the stored energy as its current ramps down while still providing current to the output.

● Current Sense

An internal current-sense amplifier senses the current through the high-side MOSFET during on time and produces a proportional current signal, which is used to sum with the slope compensation signal. The summed signal then is compared with the error amplifier output by the PWM comparator to terminate the on cycle.

● Current Limit

There is a cycle-by-cycle current limit on the high-side MOSFET of 2.5A. When the current flowing out of SW exceeds this limit, the high-side MOSFET turns off and the synchronous rectifier turns on. The FDK0520 utilizes a frequency fold-back mode to prevent overheating during short-circuit output conditions. The device enters frequency fold-back mode when the FB voltage drops below 200mV, limiting the current to 2.5A and reducing power dissipation. Normal operation resumes upon removal of the short-circuit condition.

● Soft-start

The FDK0520 has a internal soft-start circuitry to reduce supply inrush current during startup conditions. When the device exits under-voltage lockout (UVLO), shutdown mode, or restarts following a thermal-overload event, the I soft-start circuitry slowly ramps up current available at SW.

● UVLO and Thermal Shutdown

If IN drops below 2.5V, the UVLO circuit inhibits switching. Once IN rises above 2.5V, the UVLO clears, and the soft-start sequence activates. Thermal-overload protection limits total power dissipation in the device. When the junction temperature exceeds $T_J = +150^{\circ}\text{C}$, a thermal sensor forces the device into shutdown, allowing the die to cool. The thermal sensor turns the device on again after the junction temperature cools by 15°C , resulting in a pulsed output during continuous overload conditions. Following a thermal-shutdown condition, the soft-start sequence begins.

14. Application Information

• Setting Output Voltages

Output voltages are set by external resistors. The FB threshold is 0.6V.

$$R_{TOP} = R_{BOT} [V_{out}/0.6 - 1]$$

• Input Capacitor Selection

The input capacitor in a DC-to-DC converter reduces current peaks drawn from the battery or other input power source and reduces switching noise in the controller. The impedance of the input capacitor at the switching frequency should be less than that of the input source so high-frequency switching currents do not pass through the input source. The output capacitor keeps output ripple small and ensures control-loop stability. The output capacitor must also have low impedance at the switching frequency. Ceramic, polymer, and tantalum capacitors are suitable, with ceramic exhibiting the lowest ESR and high-frequency impedance. Output ripple with a ceramic output capacitor is approximately as follows:

$$V_{RIPPLE} = I_{L(PEAK)} [1/(2\pi \times f_{OSC} \times C_{OUT})]$$

If the capacitor has significant ESR, the output ripple component due to capacitor ESR is as follows: $V_{RIPPLE(ESR)} = I_{L(PEAK)} \times ESR$

• Output Capacitor and Inductor Selection

Follow the below table for Inductor and Output capselection:

V _{OUT}	1.2V	1.5V	1.8V	2.5V	3.3V
C _{OUT}	33μF	33μF	22μF	22μF	10μF
L	1.5μH	1.5μH	2.2μH	3.3μH	4.7μH

If much smaller values are used, inductor current rises, and a larger output capacitance may be required to suppress output ripple. Larger values than L_{IDEAL} can be used to obtain higher output current, but typically with larger inductor size.

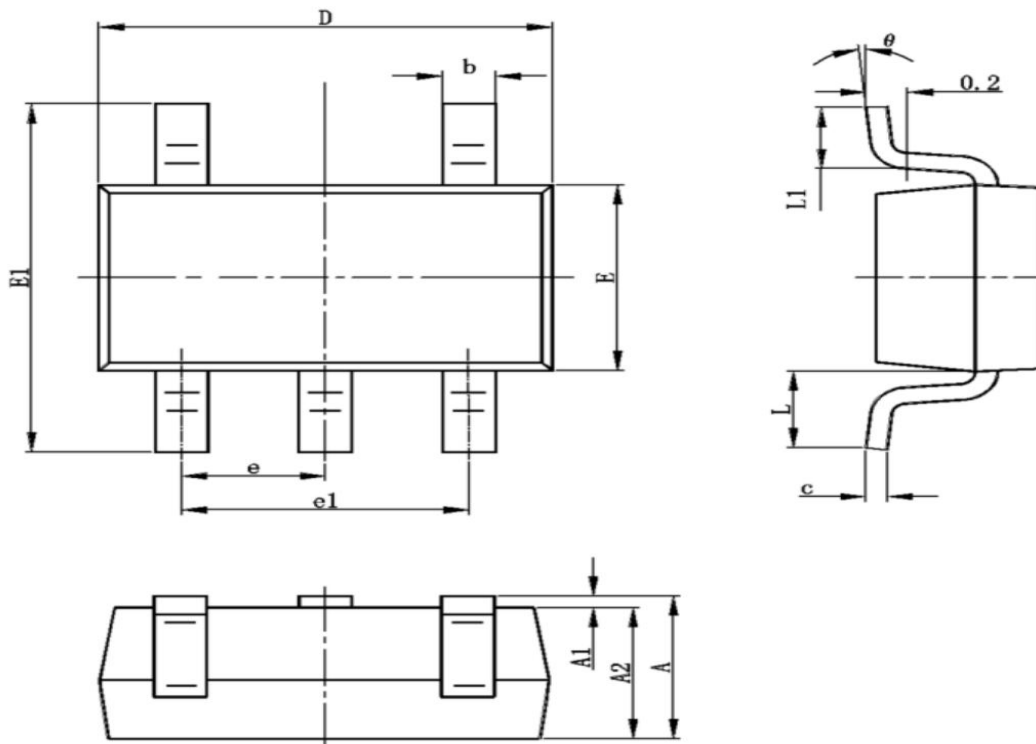
• Layout

Layout is critical to achieve clean and stable operation. The switching power stage requires particular attention. Follow these guidelines for good PC board layout:

- 1) Place decoupling capacitors as close to the IC as possible
- 2) Connect input and output capacitors to the same power ground node with a star ground configuration then to IC ground.
- 3) Keep the high-current paths as short and wide as possible. Keep the path of switching current (C1 to IN and C1 to GND) short. Avoid vias in the switching paths.
- 4) If possible, connect IN, SW, and GND separately to a large copper area to help cool the IC to further improve efficiency and long-term reliability.
- 5) Ensure all feedback connections are short and direct. Place the feedback resistors as close to the IC as possible.
- 6) Route high-speed switching nodes away from sensitive analog area.

15.Package Outline Dimensions

Package Type: SOT23-5(All dimensions in mm.)



Symbol	Dimension In Millimeters		Dimension In Inches	
	MIN	MAX	MIN	MAX
A	0.950	1.250	0.038	0.049
A1	0.000	0.100	0.000	0.004
A2	0.900	1.150	0.036	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.700 REF		0.028 REF	
L1	0.300	0.600	0.012	0.024
θ	0.	8.	0.	8°

16.Important Notice And Disclaimer

- We reserves the right to change the instruction manual without prior notice.
- Any semiconductor product has a certain possibility of failure or malfunction under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design and overall manufacturing to avoid potential failure risks that may cause personal injury or property damage.
- The improvement of product quality is endless, our company will be dedicated to provide customers with better products.